

## CMOS 8-Bit Microcontroller

**TMPA8701CHN/F, TMPA8701CKN/F, TMPA8701CMN/F**

The A8701CH/CK/CM is the high speed and high performance 8 bit single chip microcomputer. This MCU contains CPU core, ROM, RAM, input / output ports, six multi-function timer / counter, serial interface, on-screen display, data slicer, jitter elimination circuit and 8 bit A/D converter on a chip.

The functions of the OSD circuit conform to the on-screen display functions of closed caption decoders based on FCC standards.

Part No.	ROM	RAM	Package	OTP MCU
TMPA8701CHN	16 Kbytes	768 Bytes	SDIP42-P-600-1.78	TMPA8700PSN TMPA8700PSF
TMPA8701CHF			QFP44-P-1414-0.80D	
TMPA8701CKN	24 Kbytes		SDIP42-P-600-1.78	
TMPA8701CKF			QFP44-P-1414-0.80D	
TMPA8701CMN	32 Kbytes		SDIP42-P-600-1.78	
TMPA8701CMF			QFP44-P-1414-0.80D	

**Features**

- ◆ 8 bit single chip microcomputer TLCS-870 Series
- ◆ Instruction execution time : 0.5  $\mu$ s (At 8 MHz)
- ◆ 412 basic instructions
  - Multiplication and Division (8 bits  $\times$  8 bits, 16 bits  $\div$  8 bits)  
: Instruction execution time 3.5  $\mu$ s (At 8 MHz)
  - Bit manipulations (Set / Clear / Complement / Move / Test / Exclusive Or)
  - 16 bit data operations
  - 1 byte jump / subroutine-call (Short relative jump / Vector call)
- ◆ 13 interrupt sources (External : 4, Internal : 9)
  - All sources have independent latches each, and nested interrupt control is available.
  - Three edge-selectable external interrupts with noise reject
  - High-speed task switching by register bank changeover
- ◆ Input / Output ports (33 pins)
- ◆ Two 16 bit Timer / Counters
  - Timer, Event counter, Pulse width measurement, External trigger timer, Window modes
- ◆ Two 8 bit Timer / Counters
  - Timer, Event counter, Capture (Pulse width / duty measurement) modes

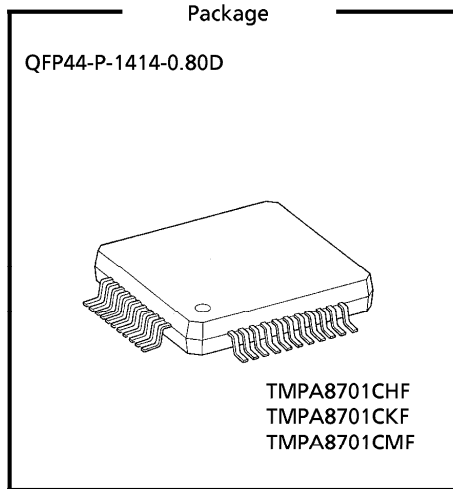
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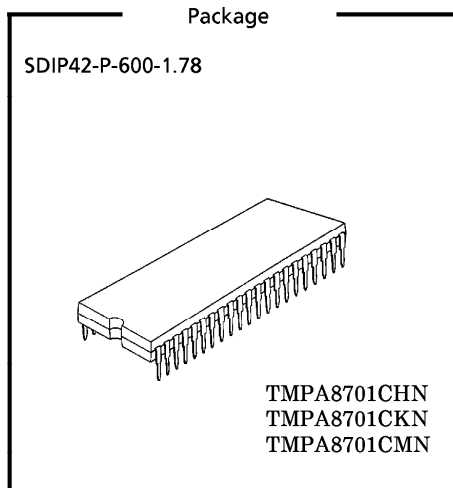
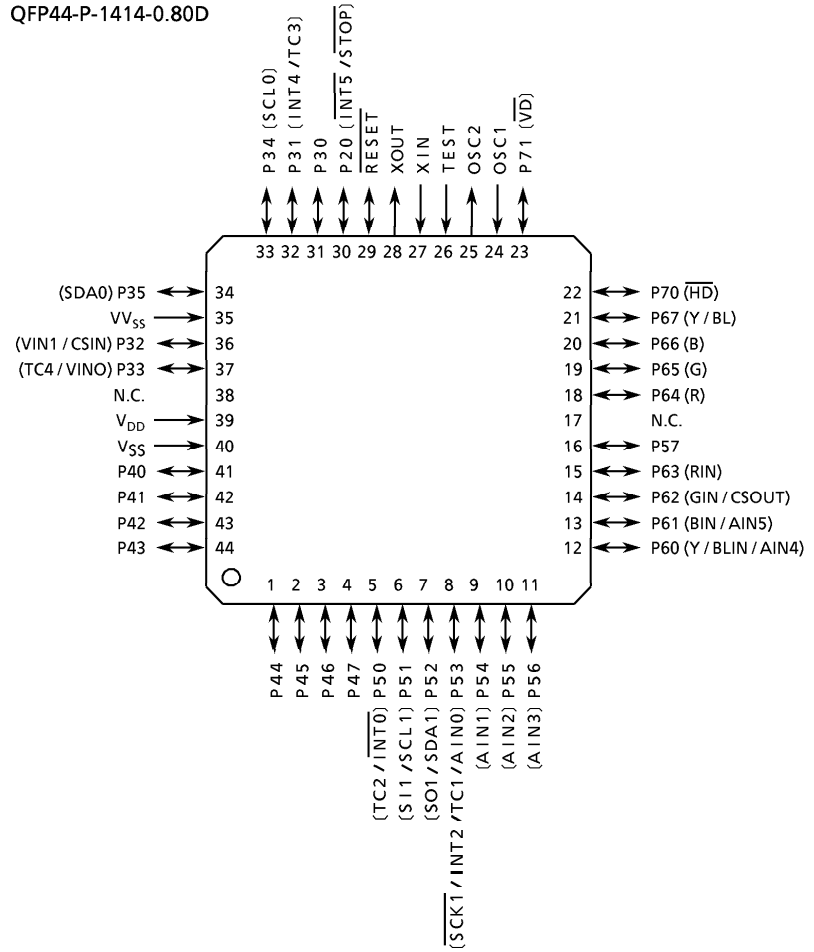
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- ◆ Time Base Timer
  - Interrupt frequency : 1 Hz to 16384 Hz
- ◆ Watchdog Timer
- ◆ Serial bus Interface
  - I<sup>2</sup>C-bus (single master) / 8 bits SIO timeshared 2ch
- ◆ On-screen display circuit
  - Character patterns : 251 characters
  - Character displayed : 32 columns 8 rows
  - Composition : 8 × 9 dots
  - Size of character : 3 kinds (Line by line)
  - Color of character : 7 kinds (Character by character)
  - Variable display position : Horizontal 128 steps, Vertical 256 steps
  - Fringing, Smoothing function
  - Conform to US CLOSED CAPTION DECODER REGULATION
- ◆ 8 bit successive approximate type A/D converter with sample and hold
  - 6 analog inputs
  - Conversion time : 23  $\mu$ s at 8 MHz
- ◆ High current outputs : LED direct drive capability (Typ. 20 mA × 4 bits).
- ◆ Data slicer circuit 1ch
- ◆ Jitter elimination circuit
- ◆ Test video signal generator
- ◆ Two Power saving operating modes
  - STOP mode : Oscillation stops. Battery / Capacitor back-up. Port output hold / high-impedance.
  - IDLE mode : CPU stops, and Peripherals operate using high-frequency clock. Release by interrupts.
- ◆ Emulation Pod : BMA8700CSN0A



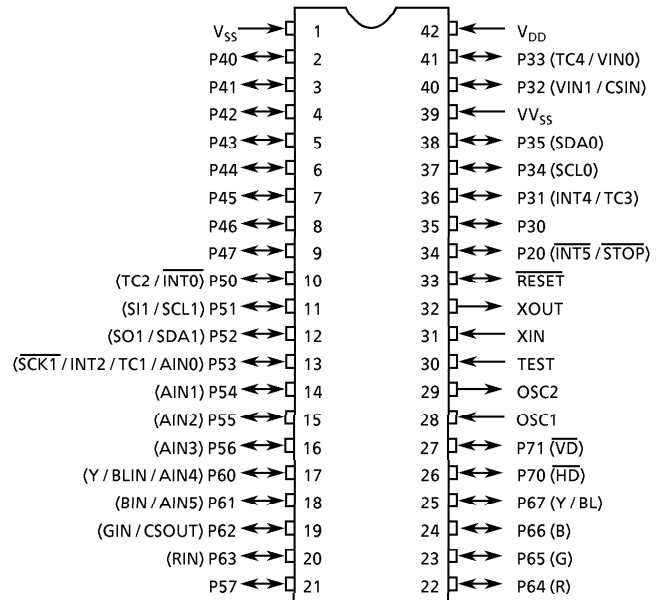
Pin Assignments (Top View)

QFP44-P-1414-0.80D

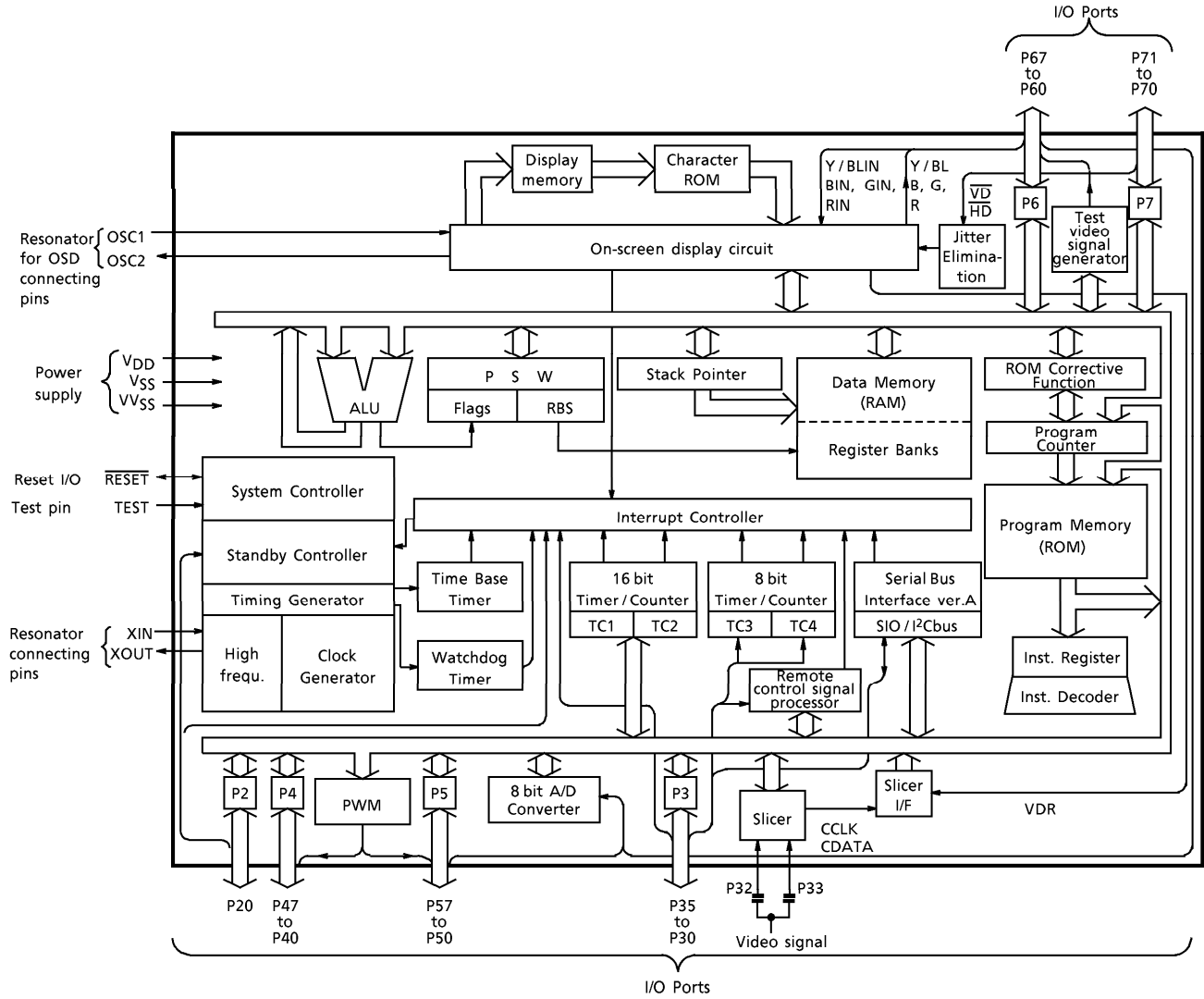


Pin Assignments (Top View)

SDIP42-P-600-1.78



Block Diagram



Pin Function

Pin No.	Pin Name	Input / Output	Function	
34	P20 ( $\overline{\text{INT5}} / \overline{\text{STOP}}$ )	I/O (Input, Input)	1 bit input / output port with latch. When used as an input port, an interrupt input or STOP mode release signal input, the latch must be set to "1". External interrupt input 5 / STOP mode release signal input	
38	P35 (SDA0)	I/O (I/O)	6 bit programmable input / output port. (tri-state) Each bit of this port can be individually as an input or an output under software control. During reset, all bits are configured as inputs. When used as an input port, a timer / counter input, data slicer input, or an interrupt input, the pin must be set to the input mode. When used as a serial bus interface input / output, the pin must be set to the sink open drain mode, the latch must be set to "1", and the pin must be set to the output mode.	
37	P34 (SCL0)	I/O (I/O)		
41	P33 (TC4 / VIN0)	I/O (Input, Input)		
40	P32 (VIN1 / CSIN)	I/O (Input, Input)		
36	P31 (INT4 / TC3)	I/O (Input, Input)	External interrupt input 4 / Timer / Counter 3 input	
35	P30	I/O		
9 to 2	P47 to P40	I/O	8 bit programmable input / output port (tri-state). Each bit of this port can be individually as an input or an output under software control. During reset, all bits are configured as inputs.	
21	P57	I/O	8 bit programmable input / output port. (tri-state) Each bit of this port can be individually as an input or an output under software control. During reset, all bits are configured as inputs. When used as an input port, a serial bus interface input, the pin must be set to the input mode. When used as serial bus interface output, the latch must be set to "1", and the pin must be set to the output mode. When used as a serial bus interface input / output, the pin must be set to the sink open drain mode, the latch must be set to "1", and the pin must be set to the output mode.	
16 to 14	P56 (AIN3) to P54 (AIN1)	I/O (Input)		
13	P53 (AIN0 / TC1 / INT2 / $\overline{\text{SCK1}}$ )	I/O (Input, Input, Input, I/O)		
12	P52 (SDA1 / SO1)	I/O (I/O, Output)		
11	P51 (SCL1 / SI1)	I/O (I/O, Input)		
10	P50 ( $\overline{\text{INT0}} / \text{TC2}$ )	I/O (Input, Input)		
27	P71 ( $\overline{\text{VD}}$ )	I/O (Input)		Vertical synchronous signal input
26	P70 ( $\overline{\text{HD}}$ )	I/O (Input)		Horizontal synchronous signal input
25	P67 (Y / BL)	I/O (Output)	8 bit programmable input / output port (tri-state, P63 to P60 : High current output). Each bit of this port can be individually as an input or an output under software control. During reset, all bits are configured as inputs. When P67 to P64 ports are used as output port, bits 7 to 4 of address 0F91H must be set to "1". When P63 to P60 port used as RIN, GIN, BIN, Y / BLIN input, these ports must be set to the input mode.	
24	P66 (B)			
23	P65 (G)			
22	P64 (R)			
20	P63 (RIN)			
19	P62 (GIN / CSOUT)			
18	P61 (BIN / AIN5)			
17	P60 (Y / BLIN / AIN4)	I/O (Input / Input)		
28, 29	OSC1, OSC2	Input, Output	Resonator connecting pin of on-screen display circuit	
31, 32	XIN, XOUT	Input, Output	Resonator connecting pin (High frequency). For external clock input, XIN is used and XOUT is opened.	
33	$\overline{\text{RESET}}$	I/O	Reset signal input or watchdog timer output / address-trap-reset output / system-clock-reset output.	
30	TEST	Input	Test pin for out-going test. Be tied to low.	
42 ; 1, 39	VDD, VSS, VVSS	Power Supply	+ 5 V, 0 V (GND)	

Operational Description

1. CPU core Functions

The CPU core consists of a CPU, a system clock controller, an interrupt controller, a watchdog timer, and ROM corrective function.

This section provides a description of the CPU core, the program memory (ROM), the data memory (RAM), and the reset circuit.

1.1 Memory Address Map

The TLC5-870 Series is capable of addressing 64 Kbytes of memory. Figure 1-1 shows the memory address maps of the A8701CH/CK/CM. In the TLC5-870 Series, the memory is organized 4 address spaces (ROM, RAM, SFR, and DBR). It uses a memory mapped I/O system, and all I/O registers are mapped in the SFR / DBR address spaces. There are 16 banks of general-purpose registers. The register banks are also assigned to the first 128 bytes of the RAM address space.

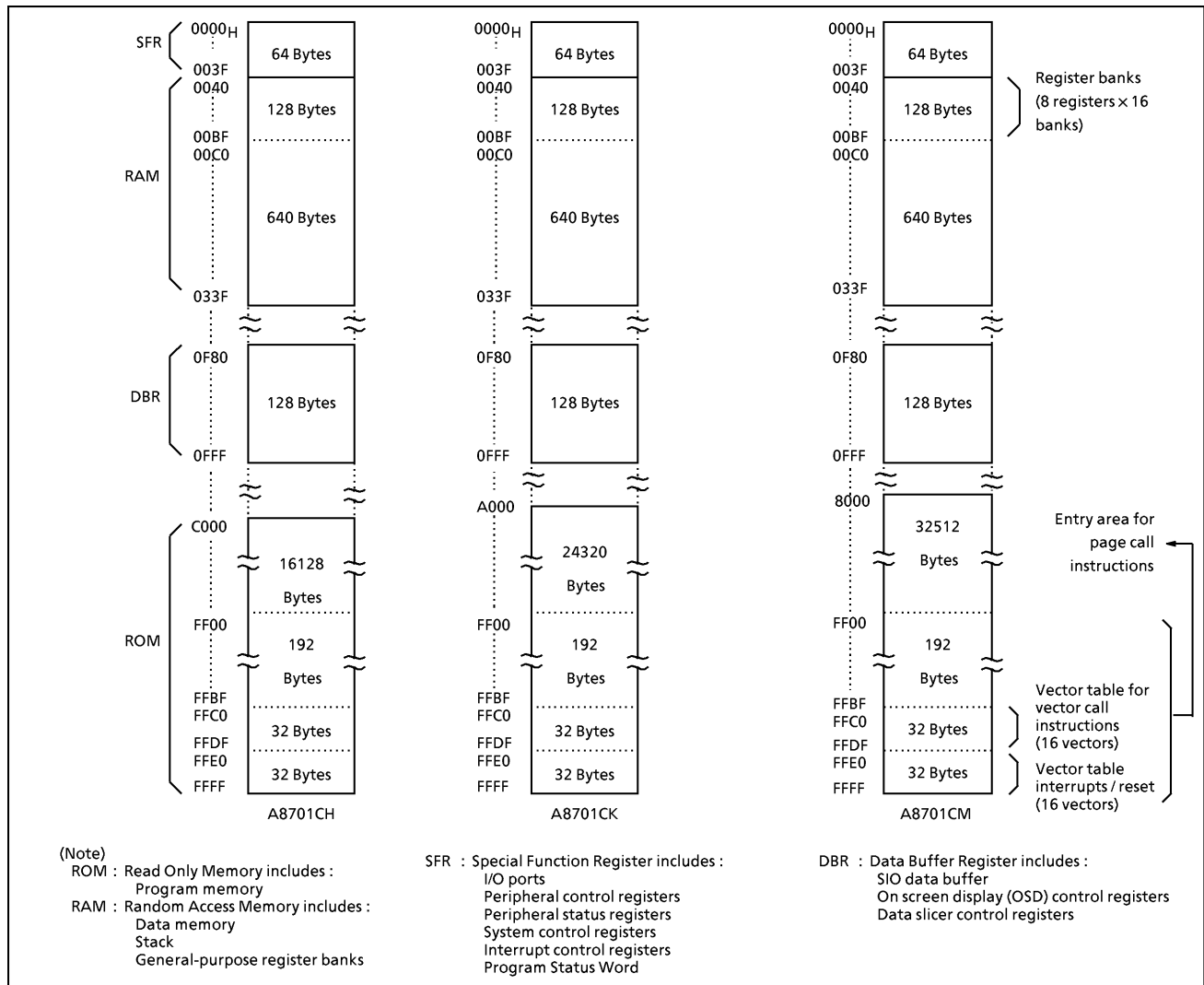


Figure 1-1. Memory Address Map

## Electrical Characteristics

## Absolute Maximum Ratings

 $(V_{SS} = 0\text{ V})$ 

Parameter	Symbol	Condition	Rating	Unit
Supply Voltage	$V_{DD}$	—	− 0.3 to 6.5	V
Input Voltage	$V_{IN}$	—	− 0.3 to $V_{DD} + 0.3$	V
Output Voltage	$V_{OUT1}$	—	− 0.3 to $V_{DD} + 0.3$	V
Output Current (Per 1pin)	$I_{OUT1}$	Ports P2, P3, P4, P5, P64 to P67, P7	3.2	mA
	$I_{OUT2}$	P60 to P63	30	
Output Current (Total)	$\Sigma I_{OUT1}$	Ports P2, P3, P4, P5, P64 to P67, P7	120	mA
	$\Sigma I_{OUT2}$	P60 to P63	120	
Power Dissipation [ $T_{opr} = 70^{\circ}\text{C}$ ]	$P_D$	—	600	mW
Soldering Temperature (time)	$T_{slid}$	—	260 (10 s)	$^{\circ}\text{C}$
Storage Temperature	$T_{stg}$	—	− 55 to 125	$^{\circ}\text{C}$
Operating Temperature	$T_{opr}$	—	− 30 to 70	$^{\circ}\text{C}$

*Note: The absolute maximum ratings are rated values which must not be exceeded during operation, even for an instant. Any one of the ratings must not be exceeded. If any absolute maximum rating is exceeded, a device may break down or its performance may be degraded, causing it to catch fire or explode resulting in injury to the user. Thus, when designing products which include this device, ensure that no absolute maximum rating value will ever be exceeded*

Recommended Operating Conditions	( $V_{SS} = 0\text{ V}$ , $T_{opr} = -30\text{ to }70^{\circ}\text{C}$ )
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Parameter	Symbol	Pins	Test Condition	Min	Max	Unit	
Supply Voltage	$V_{DD}$	—	$f_c = 8\text{ MHz}$	NORMAL mode	4.5	5.5	V
				IDLE mode			
				STOP mode	2.0		
Input High Voltage	$V_{IH1}$	Except hysteresis input	$V_{DD} \geq 4.5\text{ V}$	$V_{DD} \times 0.70$	$V_{DD}$	V	
	$V_{IH2}$	Hysteresis input		$V_{DD} \times 0.75$			
	$V_{IH3}$	—	$V_{DD} < 4.5\text{ V}$	$V_{DD} \times 0.90$			
Input Low Voltage	$V_{IL1}$	Except hysteresis input	$V_{DD} \geq 4.5\text{ V}$	0	$V_{DD} \times 0.30$	V	
	$V_{IL2}$	Hysteresis input			$V_{DD} \times 0.25$		
	$V_{IL3}$	—	$V_{DD} < 4.5\text{ V}$		$V_{DD} \times 0.10$		
Clock Frequency	$f_c$	XIN, XOUT	$V_{DD} = 4.5\text{ to }5.5\text{ V}$	—	8.0	MHz	
	$f_{OSD}$	OSC1, OSC2	$V_{DD} = 4.5\text{ to }5.5\text{ V}$	Double frequency mode (FORS = 1)	2		6
Normal frequency mode (FORS = 0)				2	12		

Note 1: The recommended operating conditions for a device are operating conditions under which it can be guaranteed that the device will operate as specified. If the device is used under operating conditions other than the recommended operating conditions (supply voltage, operating temperature range, specified AC/DC values etc.), malfunction may occur. Thus, when designing products which include this device, ensure that the recommended operating conditions for the device are always adhered to.

Note 2:  $f_c$  : The condition of power supply voltage is limited to NORMAL and IDLE mode.

Furthermore, since the CPU clock serves dual purposes as a clock for the CCD slier, always be sure to use an 8 MHz oscillator.



## Electrical Characteristics

## D.C. Characteristics

(V<sub>SS</sub> = 0 V, T<sub>opr</sub> = -30 to 70°C)

Parameter	Symbol	Pins	Test Circuit	Test Condition	Min	Typ.	Max	Unit
Hysteresis Voltage	V <sub>HS</sub>	Hysteresis inputs	—	—	—	0.9	—	V
Input Current	I <sub>IN1</sub>	TEST	—	V <sub>DD</sub> = 5.5 V, V <sub>IN</sub> = 5.5 V / 0 V	—	—	± 2	μA
	I <sub>IN2</sub>	Open drain ports	—	V <sub>DD</sub> = 5.5 V, V <sub>IN</sub> = 5.5 V / 0 V	—	—	± 2	
	I <sub>IN3</sub>	Tri-state ports	—	V <sub>DD</sub> = 5.5 V, V <sub>IN</sub> = 5.5 V / 0 V	—	—	± 2	
	I <sub>IN4</sub>	RESET, STOP						
Input Resistance	R <sub>IN2</sub>	RESET	—	—	100	220	450	kΩ
Output Leakage Current	I <sub>LO</sub>	Open drain ports and tri-state ports	—	V <sub>DD</sub> = 5.5 V, V <sub>OUT</sub> = 5.5 V	—	—	2	μA
Output High Voltage	V <sub>OH2</sub>	Tri-state ports	—	V <sub>DD</sub> = 4.5 V, I <sub>OH</sub> = -0.7 mA	4.1	—	—	V
Output Low Voltage	V <sub>OL</sub>	Except XOUT, OSC2, P60 to 63	—	V <sub>DD</sub> = 4.5 V, I <sub>OL</sub> = 1.6 mA	—	—	0.4	V
Output Low Current	I <sub>OL3</sub>	P60 to P63	—	V <sub>DD</sub> = 4.5 V, V <sub>OL</sub> = 1.0 V	—	20	—	mA
Supply Current in NORMAL Mode	I <sub>DD</sub>	—	—	V <sub>DD</sub> = 5.5 V (Note 3) f <sub>c</sub> = 8 MHz V <sub>IN</sub> = 5.3 V / 0.2 V	—	12	25	mA
Supply Current in IDLE Mode					—	8	18	mA
Supply Current in STOP Mode					—	0.5	10	μA

Note 1: Typical values show those at T<sub>opr</sub> = 25°C, V<sub>DD</sub> = 5 V.

Note 2: Input Current: The current through pull-up or pull-down resistor is not included.

Note 3: Typical current consumption during A / D conversion is 1.2 mA.

## A/D Conversion Characteristics

(V<sub>SS</sub> = 0 V, V<sub>DD</sub> = 4.5 to 5.5 V, T<sub>opr</sub> = -30 to 70°C)

Parameter	Symbol	Test Circuit	Test Condition	Min	Typ.	Max	Unit
Analog Reference Voltage	V <sub>AREF</sub>	—		—	V <sub>DD</sub>	—	V
	V <sub>ASS</sub>			—	0	—	
Analog Reference Voltage Range	ΔV <sub>AREF</sub>	—	= V <sub>DD</sub> - V <sub>SS</sub>	—	V <sub>DD</sub>	—	V
Analog Input Voltage	V <sub>AIN</sub>	—		V <sub>SS</sub>	—	V <sub>DD</sub>	V
Nonlinearity Error	—	—	V <sub>DD</sub> = 4.5 to 5.5 V	—	—	± 1	LSB
Zero Point Error	—	—		—	—	± 2	LSB
Full Scale Error	—	—		—	—	± 2	LSB
Total Error	—	—		—	—	± 3	LSB

Note: Total error does not include quantization error.

**A.C. Characteristics**

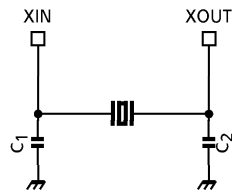
( $V_{SS} = 0\text{ V}$ ,  $V_{DD} = 4.5\text{ to }5.5\text{ V}$ ,  $T_{opr} = -30\text{ to }70^\circ\text{C}$ )

Parameter	Symbol	Test Circuit	Test Condition	Min	Typ.	Max	Unit
Machine Cycle Time	tcy	—	In NORMAL mode	—	0.5	—	$\mu\text{s}$
			In IDLE mode				
High Level Clock Pulse Width	t <sub>WCH</sub>	—	For external clock operation (XIN input), f <sub>c</sub> = 8 MHz	62.5	—	—	ns
Low Level Clock Pulse Width	t <sub>WCL</sub>						

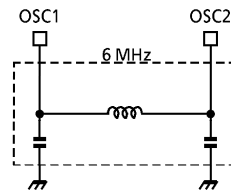
**Recommended Oscillating**

( $V_{SS} = 0\text{ V}$ ,  $V_{DD} = 4.5\text{ to }5.5\text{ V}$ ,  $T_{opr} = -30\text{ to }70^\circ\text{C}$ )

Parameter	Oscillator	Frequency	Recommended Oscillator		Recommended Conditions	
					C <sub>1</sub>	C <sub>2</sub>
High-frequency	Ceramic Resonator	8 MHz	KYOCERA	KBR8.0M	30 pF	30 pF
	Crystal Oscillator	8 MHz	TOYOCOM	210B 8.0000	20 pF	20 pF
OSD	LC Resonator	6 MHz	TOKO	A285HCIS-13319 (5 mm)	—	—
		12 MHz	TOKO	TA285HCIS-13306 (5 mm)		



(1) High-frequency



(2) LC Resonator for OSD

*Note: An electrical shield by metal shield plate on the surface of the IC package should be recommendable in order to prevent the device from the high electric fieldstress applied from CRT (Cathode Ray Tube) for continuous reliable operation.*